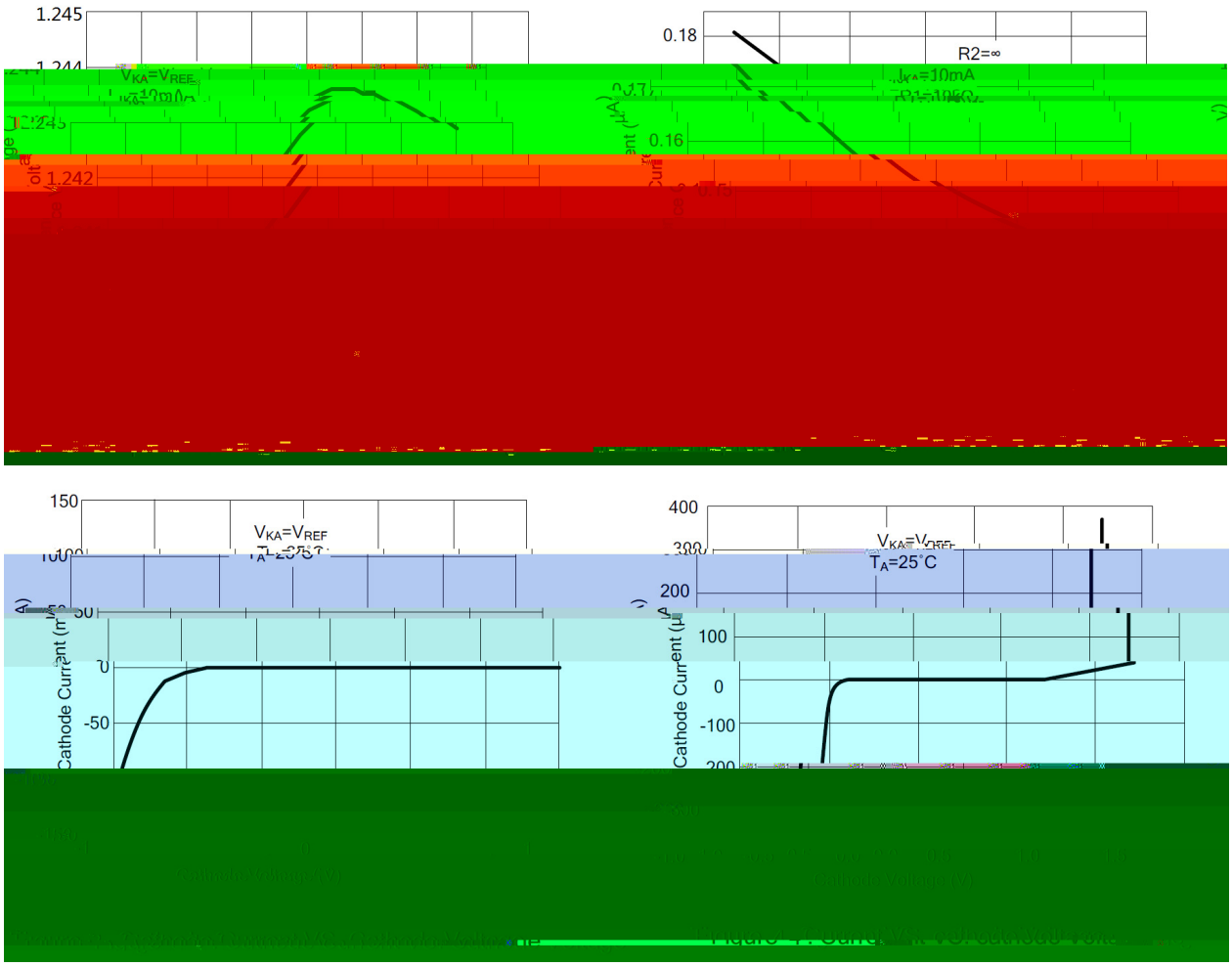
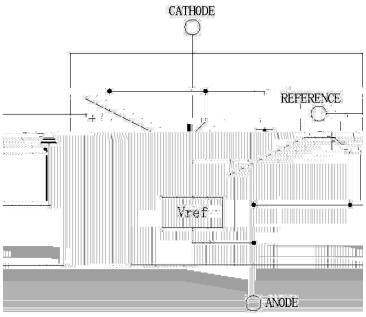
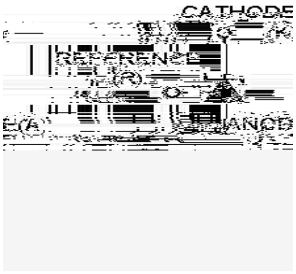
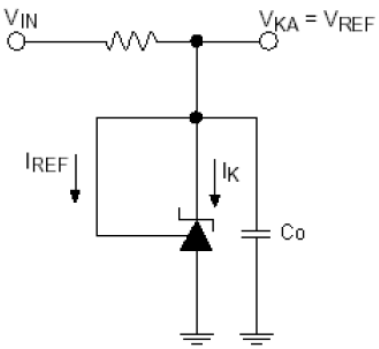

/ Electrical Characteristic Curve



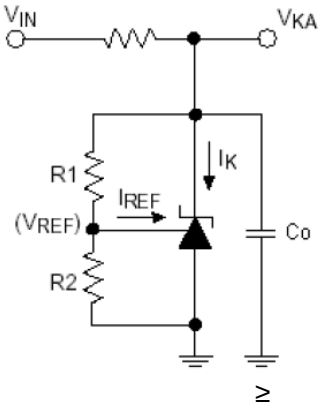
& Test circuits&Typical Application





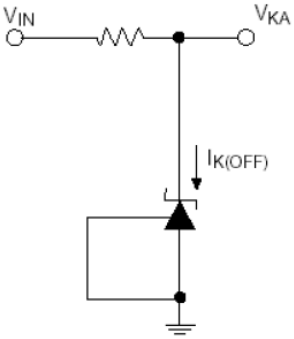


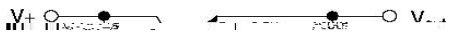
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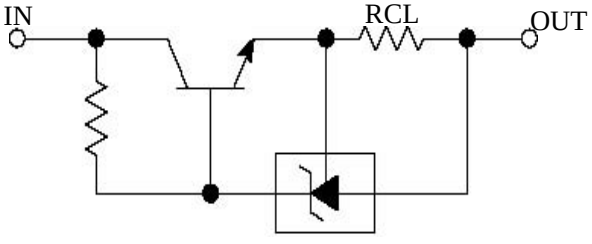
≥

μ

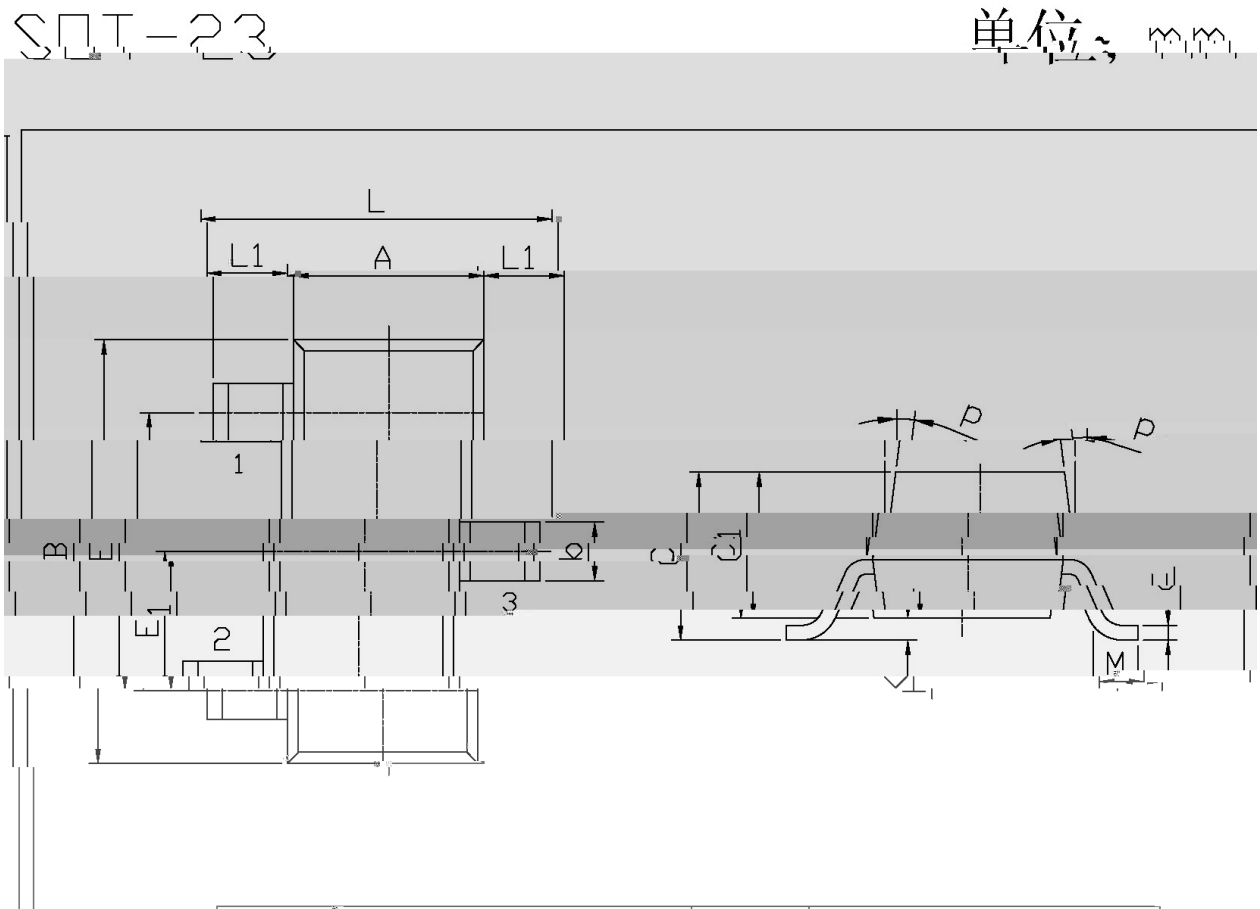




Io=V_{REF}/RCL+I_{KA}

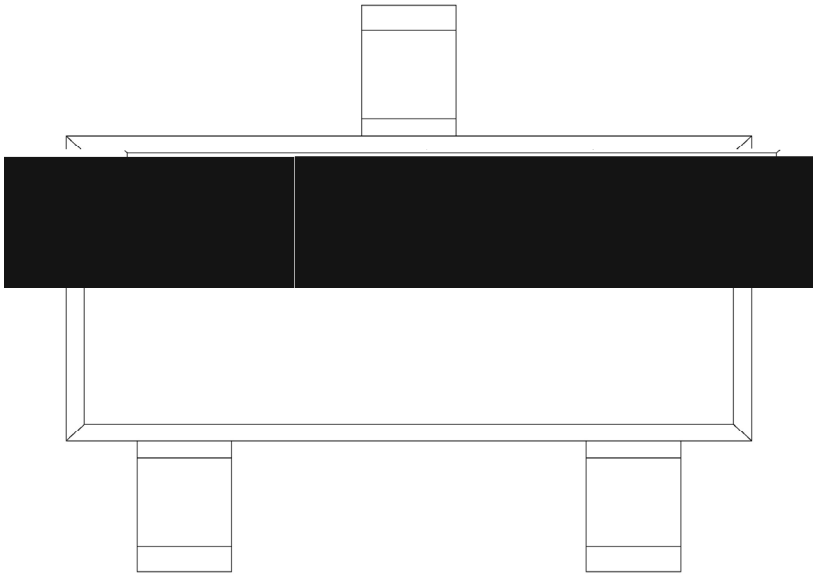


/ Package Dimensions



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min.	Max		Min.	Max
L	2.2	2.7	C	1.30Max	
L1	0.45	0.65	C1	0.90	1.20

/ Marking Instructions



( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)

/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box

/ Notices